

REV.	DESCRIPTION	DATE
A/0	新版发行	2016.11.28

技术要求:

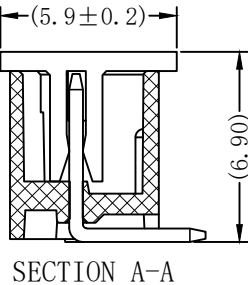
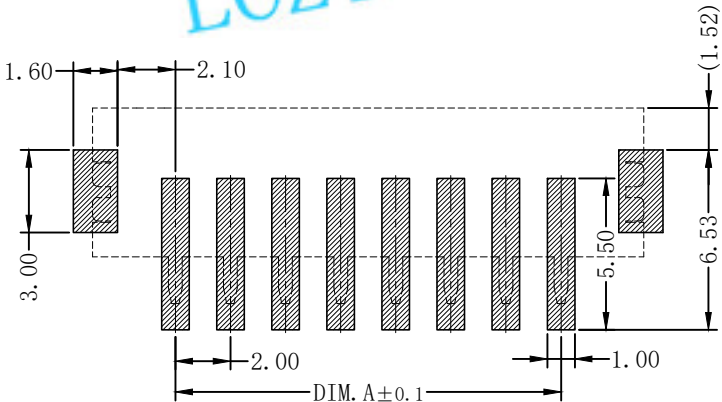
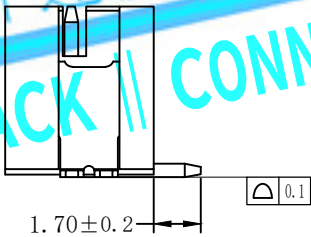
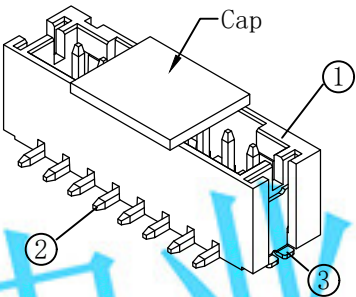
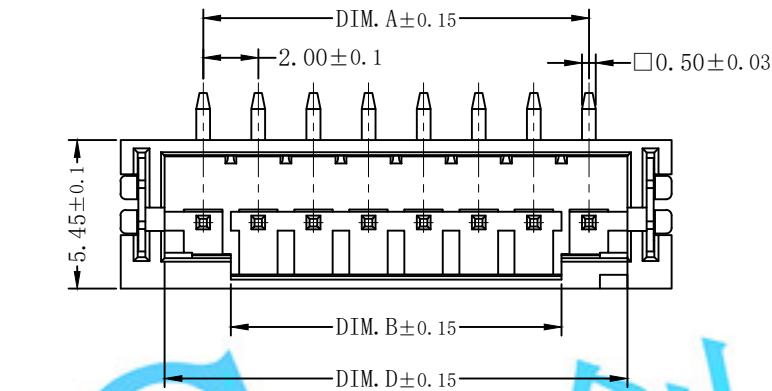
- 1、塑件材料: LCP (UL-94V-0)
- 2、接触件: 黄铜镀锡
- 3、接触电阻: $\leq 10\text{m}\Omega$
- 4、绝缘电阻: $\geq 1000\text{M}\Omega$
- 5、额定电压: 250V AC DC
- 6、额定电流: 2.0A AC DC
- 7、耐压: 能承受1000V AC/Minute
- 8、工作温度: $-25^{\circ}\sim +105^{\circ}$
- 9、可焊性试验: 浸锡面积 $\geq 95\%$ 温度 260^{+5}_{-0} , 时间 2.5 ± 0.5 秒
- 10、铅和镉等六大有害物质含量要符合环保要求

PH-2.0-XP-LT

Circuits	Dimensions (mm)			
	A	B	C	D
02	2.00	1.00	8.00	4.80
03	4.00	2.00	10.00	6.80
04	6.00	4.00	12.00	8.80
05	8.00	6.00	14.00	10.80
06	10.00	8.00	16.00	12.80
07	12.00	10.00	18.00	14.80
08	14.00	12.00	20.00	16.80
09	16.00	14.00	22.00	18.80
10	18.00	16.00	24.00	20.80
11	20.00	18.00	26.00	22.80
12	22.00	20.00	28.00	24.80
13	24.00	22.00	30.00	26.80
...	...	...	...	...
20	38.00	36.00	44.00	40.80

3	焊片 Fitting Nail	黄铜 Brass	2	电镀(锡): 整个表面镀底镍30u"MIN, 再镀锡80u"MIN.
2	端子 Contact	黄铜 Brass	n*1	电镀(锡): 整个表面镀底镍30u"MIN, 再镀锡80u"MIN.
1	基座 Wafer	LCP (UL94V-0)	1	本色
序号	名称	材料	数量	附注

GENERAL TOLERANCES				龙创中业电子科技(东莞)有限公司	
0.X	± 0.25	X.*	$\pm 3^{\circ}$		
0.XX	± 0.12				
0.XXX	± 0.05	X.X*	$\pm 0.5^{\circ}$		
UNIT	SIZE	SCALE	DRAWING NO. 006-0082-001	SHEET 1 OF 1	PROD. NAME PART NO. PH-2.0-XP-LT
MM	A4	1:1		TITLE 2.00 FPC CONN. ZIF SMT FRONTFLIP H=2.0 DOUBLE LOWER CONTACT	



SUGGESTED PCB LAYOUT
(COMPONENT SIDE)